

Data Sheet

FEATURES

Latch-up immune under all circumstances Human body model (HBM) ESD rating: 8 kV Low on resistance: 13.5 Ω ±9 V to ±22 V dual-supply operation 9 V to 40 V single-supply operation 48 V supply maximum ratings Fully specified at ±15 V, ±20 V, +12 V, and +36 V V_{DD} to V_{SS} analog signal range

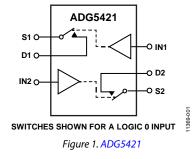
APPLICATIONS

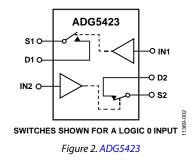
High voltage signal routing Automatic test equipment Analog front-end circuits Precision data acquisition Industrial instrumentation Amplifier gain select Relay replacement

High Voltage Latch-Up Proof, Dual SPST Switches

ADG5421/ADG5423

FUNCTIONAL BLOCK DIAGRAMS





GENERAL DESCRIPTION

The ADG5421/ADG5423 are monolithic industrial, complementary metal oxide semiconductor (CMOS) analog switches containing two independent latch-up immune singlepole/single-throw (SPST) switches. Each switch conducts equally well in both directions when on, and has an input signal range that extends to the power supplies. In the off condition, signal levels up to the supplies are blocked. Both ADG5421 switches are turned on with a Logic 1 input, whereas the ADG5423 has one switch turned on and one switch turned off for a Logic 1 input. The ADG5423 exhibits break-before-make action for use in multiplexer applications.

The ultralow on resistance and on-resistance flatness of these switches make them ideal solutions for data acquisition and gain switching applications where low distortion is critical. The latch-up immune construction and high ESD rating make these switches more robust in harsh environments.

PRODUCT HIGHLIGHTS

- 1. Trench isolation guards against latch-up. A dielectric trench separates the P channel and N channel transistors, thereby preventing latch-up even under severe overvoltage conditions.
- 2. Low R_{ON} of 13.5 Ω .
- 3. Dual-supply operation. For applications where the analog signal is bipolar, the ADG5421/ADG5423 can operate from dual supplies up to ±22 V.
- 4. Single-supply operation. For applications where the analog signal is unipolar, the ADG5421/ADG5423 can operate from a single-rail power supply up to 40 V.
- 5. 3 V logic compatible digital inputs: $V_{INH} = 2.0$ V, $V_{INL} = 0.8$ V.
- 6. No V_L logic power supply required.
- 7. Available in 10-lead MSOP package.

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REVISION HISTORY

9/13—Revision 0: Initial Version

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SPECIFICATIONS

±15 V DUAL SUPPLY

 V_{DD} = +15 V \pm 10%, V_{SS} = –15 V \pm 10%, GND = 0 V, unless otherwise noted.

Table 1.

Parameter	25°C	–40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V _{DD} to V _{SS}	V	
On Resistance, R _{ON}	13.5			Ωtyp	$V_s = \pm 10 \text{ V}$, $I_s = -10 \text{ mA}$; see Figure 2
	15	19	23	Ωmax	$V_{DD} = +13.5 \text{ V}, \text{V}_{SS} = -13.5 \text{ V}$
On-Resistance Match Between Channels,	0.1			Ωtyp	$V_{s} = \pm 10 V$, $I_{s} = -10 mA$
ΔR _{on}					
	0.8	1.3	1.4	Ωmax	
On-Resistance Flatness, R _{FLAT (ON)}	1.8			Ωtyp	$V_{s} = \pm 10 V$, $I_{s} = -10 mA$
	2.2	2.7	3.1	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = +16.5 \text{ V}, V_{SS} = -16.5 \text{ V}$
Source Off Leakage, I _s (Off)	±0.05			nA typ	$V_s = \pm 10 V$, $V_D = \mp 10 V$; see Figure 23
	±0.25	±1	±10	nA max	
Drain Off Leakage, I _D (Off)	±0.05			nA typ	$V_s = \pm 10 V$, $V_D = \mp 10 V$; see Figure 23
-	±0.25	±1	±10	nA max	
Channel On Leakage, I₂ (On), I₅ (On)	±0.1			nA typ	$V_{\rm S} = V_{\rm D} = \pm 10$ V; see Figure 22
	±0.1 ±0.4	±4	±20	nA max	
DIGITAL INPUTS				- III CHIAX	
Input High Voltage, V _{INH}			2.0	V min	
Input Low Voltage, VINH			0.8	V max	
Input Current, I _{INL} or I _{INH}	0.002		0.0	μA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
	0.002		±0.1	μA max	
Digital Input Capacitance, C _{IN}	6		±0.1	pF typ	
DYNAMIC CHARACTERISTICS ¹	0			prop	
ton	185			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
ton	220	273	313	ns max	$V_{\rm s} = 10$ V; see Figure 29
t _{OFF}	163	275	515	ns typ	$R_{\rm L} = 300 \Omega, C_{\rm L} = 35 \text{pF}$
COFF	196	219	242	ns max	$V_{\rm S} = 10$ V; see Figure 29
Break-Before-Make Time Delay, t _D	73	215	272	ns typ	$R_L = 300 \Omega, C_L = 35 pF$
(ADG5423 Only)	/5			nstyp	n _L = 500 12, C _L = 55 pr
			21	ns min	$V_{S1} = V_{S2} = 10 V$; see Figure 31
Charge Injection, Q _{INJ}	95			pC typ	$V_{s} = 0 V, R_{s} = 0 \Omega, C_{L} = 1 nF;$ see
				. ,.	Figure 30
Off Isolation	-55			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see
					Figure 25
Channel-to-Channel Crosstalk	-85			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$;
					see Figure 28
Total Harmonic Distortion + Noise	0.01			% typ	R _L = 1 kΩ, 15 V p-p, f = 20 Hz to \$" kHz; see Figure 26
–3 dB Bandwidth	250				$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 27
	-1			MHz typ	
Insertion Loss	-1			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 27
C _s (Off)	12			pF typ	$V_{s} = 0 V, f = 1 MHz$
C_{D} (Off)	13			pF typ	$V_{s} = 0 V, f = 1 MHz$
C_D (On), C_s (On)	44			pF typ	$V_{s} = 0 V, f = 1 MHz$
POWER REQUIREMENTS	+			<u> </u>	$V_{DD} = +16.5 \text{ V}, V_{SS} = -16.5 \text{ V}$
	45			μA typ	Digital inputs = $0 \text{ V or } V_{DD}$
עטי	43 55		70	μA typ μA max	
lss	0.001		/0	μΑ max μΑ typ	Digital inputs = 0 V or V_{DD}
122	0.001		1	μΑ typ μΑ max	
				•	
V _{DD} /V _{SS}			±9/±22	V min/V max	GND = 0 V

±20 V DUAL SUPPLY

 V_{DD} = +20 V \pm 10%, V_{SS} = -20 V \pm 10%, GND = 0 V, unless otherwise noted.

Table 2.

Parameter	25°C	–40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V_{DD} to V_{SS}	v	
On Resistance, R _{ON}	12.5			Ωtyp	V_{S} = ±15 V, I_{S} = -10 mA; see Figure 24
	14	18	22	Ωmax	$V_{DD} = +18 \text{ V}, V_{SS} = -18 \text{ V}$
On-Resistance Match Between Channels, ΔR_{ON}	0.1			Ωtyp	$V_s = \pm 15 V$, $I_s = -10 mA$
	0.8	1.3	1.4	Ωmax	
On-Resistance Flatness, R _{FLAT (ON)}	2.3			Ωtyp	$V_s = \pm 15 V$, $I_s = -10 mA$
	2.7	3.3	3.7	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = +22 V, V_{SS} = -22 V$
Source Off Leakage, Is (Off)	±0.05			nA typ	$V_{s} = \pm 15 \text{ V}, V_{D} = \mp 15 \text{ V}; \text{ see Figure 23}$
	±0.25	±1	±10	nA max	
Drain Off Leakage, I _D (Off)	±0.05			nA typ	$V_S = \pm 15 \text{ V}, V_D = \mp 15 \text{ V};$ see Figure 23
	±0.25	±1	±10	nA max	
Channel On Leakage, I _D (On), I _s (On)	±0.1			nA typ	$V_s = V_D = \pm 15 V$; see Figure 22
	±0.4	±4	±20	nA max	
DIGITAL INPUTS					
Input High Voltage, VINH			2.0	V min	
Input Low Voltage, V _{INL}			0.8	V max	
Input Current, I _{INL} or I _{INH}	0.002			μA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	μA max	
Digital Input Capacitance, C _{IN}	6			pF typ	
DYNAMIC CHARACTERISTICS ¹					
t _{ON}	168			ns typ	R_L = 300 $\Omega,$ C_L = 35 pF, V_S = 10 V; see Figure 29
	199	243	276	ns max	$V_s = 10 V$; see Figure 29
toff	156			ns typ	$R_L = 300 \ \Omega$, $C_L = 35 \ pF$
	184	204	218	ns max	$V_s = 10 V$; see Figure 29
Break-Before-Make Time Delay, t _D (ADG5423 Only)	65			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
			38	ns min	$V_{s1} = V_{s2} = 10 V$; see Figure 31
Charge Injection, Q _{INJ}	120			pC typ	$V_s = 0 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 30
Off Isolation	-55			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 25
Channel-to-Channel Crosstalk	-85			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 28
Total Harmonic Distortion + Noise	0.01			% typ	R _L = 1 kΩ, 20 V p-p, f = 20 Hz to 20 kHz; see Figure 26
–3 dB Bandwidth	250			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 27
Insertion Loss	-0.8			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 27
C _s (Off)	11			pF typ	$V_s = 0 V$, f = 1 MHz
C _D (Off)	12			pF typ	$V_{s} = 0 V, f = 1 MHz$
C _D (On), C _s (On)	44			pF typ	$V_{s} = 0 V, f = 1 MHz$
POWER REQUIREMENTS					$V_{DD} = +22 V, V_{SS} = -22 V$
I _{DD}	50			µA typ	Digital inputs = $0 V \text{ or } V_{DD}$
	70		110	μA max	
I ₅₅	0.001		1	μA typ μA max	Digital inputs = $0 V \text{ or } V_{DD}$
	1	1		μπιπαλ	1

12 V SINGLE SUPPLY

 V_{DD} = 12 V \pm 10%, V_{SS} = 0 V, GND = 0 V, unless otherwise noted.

Table 3.

Parameter	25°C	-40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V _{DD}	V	
On Resistance, Ron	26			Ωtyp	$V_s = 0 V$ to 10 V, $I_s = -10 mA$; see Figure 24
	30	38	44	Ωmax	$V_{DD} = 10.8 V, V_{SS} = 0 V$
On-Resistance Match Between Channels, ΔR_{ON}	0.1			Ω typ	$V_{s}=0\ V\ to\ 10\ V,\ I_{s}=-10\ mA$
	1	1.5	1.6	Ωmax	
On-Resistance Flatness, R _{FLAT (ON)}	5.5			Ωtyp	$V_s = 0 V$ to 10 V, $I_s = -10 mA$
	6.8	8.3	12.3	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = +13.2 \text{ V}, \text{ V}_{SS} = 0 \text{ V}$
Source Off Leakage, Is (Off)	±0.05			nA typ	V_{s} = 1 V to 10 V, V_{D} = 10 V to 1 V; see Figure 23
	±0.25	±1	±10	nA max	
Drain Off Leakage, I_D (Off)	±0.05			nA typ	$V_s = 1$ V to 10 V, $V_D = 10$ V to 1 V; see Figure 23
	±0.25	±1	±10	nA max	
Channel On Leakage, I₂ (On), I₅ (On)	±0.1			nA typ	$V_s = V_D = 1 V$ to 10 V; see Figure 22
	±0.4	±4	±20	nA max	
DIGITAL INPUTS					
Input High Voltage, VINH			2.0	V min	
Input Low Voltage, VINL			0.8	V max	
Input Current, I _{INL} or I _{INH}	0.002			μA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	µA max	
Digital Input Capacitance, C _{IN}	6			pF typ	
DYNAMIC CHARACTERISTICS ¹				F: 9F	
ton	295			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	370	470	540	ns max	$V_s = 8 V$; see Figure 29
t _{off}	192			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
-011	235	273	295	ns max	$V_s = 8 V$; see Figure 29
Break-Before-Make Time Delay, t _D (ADG5423 Only)	142			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
			78	ns min	$V_{s1} = V_{s2} = 8 V$; see Figure 31
Charge Injection, Q_{INJ}	55			pC typ	$V_s = 6 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 30
Off Isolation	-55			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 25
Channel-to-Channel Crosstalk	-85			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 28
Total Harmonic Distortion + Noise	0.03			% typ	$R_L = 1 \text{ k}\Omega$, 6 V p-p, f = 20 Hz to 20 kHz; see Figure 26
–3 dB Bandwidth	290			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 27
Insertion Loss	-1.7			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 27
Cs (Off)	14			pF typ	$V_{s} = 6 V, f = 1 MHz$
C _D (Off)	15			pF typ	$V_{s} = 6 V, f = 1 MHz$
C _D (On), C _s (On)	38			pF typ	$V_s = 6 V, f = 1 MHz$
POWER REQUIREMENTS					$V_{DD} = 13.2 V$
IDD	40 50		65	μA typ μA max	Digital inputs = 0 V or V_{DD}
V _{DD}			9/40	V min/V max	$GND = 0 V, V_{ss} = 0 V$

36 V SINGLE SUPPLY

 V_{DD} = 36 V \pm 10%, V_{SS} = 0 V, GND = 0 V, unless otherwise noted.

Table 4.

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V _{DD}	V	
On Resistance, Ron	14.5			Ωtyp	$V_s = 0 V$ to 30 V, $I_s = -10 mA$; see Figure 24
	16	20	24	Ωmax	$V_{DD} = 32.4 \text{ V}, V_{SS} = 0 \text{ V}$
On-Resistance Match Between Channels, ΔR_{ON}	0.1			Ωtyp	$V_{s} = 0 V$ to 30 V, $I_{s} = -10 \text{ mA}$
	0.8	1.3	1.4	Ωmax	
On-Resistance Flatness, R _{FLAT (ON)}	3.5			Ωtyp	$V_s = 0 V$ to 30 V, $I_s = -10 mA$
	4.3	5.5	6.5	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = 39.6 V, V_{SS} = 0 V$
Source Off Leakage, I_s (Off)	±0.05			nA typ	$V_s = 1 V$ to 30 V, $V_D = 30 V$ to 1 V; see Figure 23
	±0.25	±1	±10	nA max	-
Drain Off Leakage, I_D (Off)	±0.05			nA typ	$V_{S} = 1 V$ to 30 V, $V_{D} = 30 V$ to 1 V; see Figure 23
	±0.25	±1	±10	nA max	
Channel On Leakage, I _D (On), I _s (On)	±0.1			nA typ	$V_s = V_D = 1 V$ to 30 V; see Figure 22
	±0.4	±4	±20	nA max	
DIGITAL INPUTS					
Input High Voltage, V _{INH}			2.0	V min	
Input Low Voltage, VINL			0.8	V max	
Input Current, I_{INL} or I_{INH}	0.002			µA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
	0.002		±0.1	µA max	
Digital Input Capacitance, C _{IN}	6			pF typ	
DYNAMIC CHARACTERISTICS ¹	-			P: 9P	
ton	181			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
CON	210	245	280	ns max	$V_s = 18 V;$ see Figure 29
toff	170	215	200	ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
COFF	192	205	220	ns max	$V_s = 18 V;$ see Figure 29
Break-Before-Make Time Delay, t _D	66	205	220	ns typ	$R_L = 300 \Omega, C_L = 35 \text{ pF}$
(ADG5423 Only)	00		27		
Channel Line (1997)	110		37	ns min	$V_{s1} = V_{s2} = 18$ V; see Figure 31
Charge Injection, Q _{INJ}	110			pC typ	$V_s = 18 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 30
Off Isolation	-55			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 25
Channel-to-Channel Crosstalk	-85			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 28
Total Harmonic Distortion + Noise	0.01			% typ	$R_L = 1 \text{ k}\Omega$, 18 V p-p, f = 20 Hz to 20 kHz; see Figure 26
–3 dB Bandwidth	260			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 27
Insertion Loss	-0.9			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 27
C _s (Off)	13			pF typ	$V_{s} = 18 V, f = 1 MHz$
C _D (Off)	16			pF typ	$V_s = 18 V, f = 1 MHz$
C _D (On), C _s (On)	38			pF typ	$V_s = 18 V, f = 1 MHz$
POWER REQUIREMENTS					$V_{DD} = 39.6 V$
I _{DD}	80			μA typ	Digital inputs = $0 V \text{ or } V_{DD}$
	100		130	μA max	
V _{DD}			9/40	V min/V max	$GND = 0 V, V_{ss} = 0 V$

CONTINUOUS CURRENT PER CHANNEL, Sx OR Dx

Table 5.

Parameter	25°C	85°C	125°C	Unit	Test Conditions/Comments
CONTINUOUS CURRENT, Sx OR Dx					MSOP ($\theta_{JA} = 133.1^{\circ}C/W$)
$V_{DD} = +15 V$, $V_{SS} = -15 V$	84	58	39	mA maximum	
$V_{DD} = +20 V$, $V_{SS} = -20 V$	89	60	41	mA maximum	
$V_{DD} = 12 V, V_{SS} = 0 V$	67	47	32	mA maximum	
$V_{DD} = 36 V, V_{SS} = 0 V$	87	59	40	mA maximum	

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}$ C, unless otherwise noted.

Table 6.

_		
Parameter	Rating	
V _{DD} to V _{SS}	48 V	
V _{DD} to GND	–0.3 V to +48 V	
Vss to GND	+0.3 V to -48 V	
Analog Inputs ¹	V _{ss} – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first	
Digital Inputs ¹	V _{SS} – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first	
Peak Current, Sx or Dx Pins	300 mA (pulsed at 1 ms, 10% duty cycle maximum)	
Continuous Current, Sx or Dx ²	Data + 15%	
Temperature Range		
Operating	–40°C to +125°C	
Storage	–65°C to +150°C	
Junction Temperature	150°C	
Thermal Impedance, θ _{JA}		
10-Lead MSOP (4-Layer Board)	133.1°C/W	
Reflow Soldering Peak Temperature, Pb Free	As per JEDEC J-STD-020	
Human Body Model (HBM) ESD	8 kV	

¹ Overvoltages at the INx, Sx, and Dx pins are clamped by internal diodes. Limit current to the maximum ratings given.

² See Table 5.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Only one absolute maximum rating can be applied at any one time.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Description	
1	S1	Source Terminal 1. This pin can be an input or output.	
2	S2	Source Terminal 2. This pin can be an input or output.	
3	NC	No Connect. Not internally connected.	
4	GND	Ground (0 V) Reference.	
5	V _{DD}	Most Positive Power Supply Potential.	
6	IN2	Logic Control Input.	
7	IN1	Logic Control Input.	
8	Vss	Most Negative Power Supply Potential.	
9	D2	Drain Terminal 2. This pin can be an input or output.	
10	D1	Drain Terminal 1. This pin can be an input or output.	

Table 8. ADG5421 Truth Table

INx	Switch Conditions
0	Off
1	On

Table 9. ADG5423 Truth Table

INx	Switch 1 Condition	Switch 2 Condition
0	Off	On
1	On	Off

TYPICAL PERFORMANCE CHARACTERISTICS

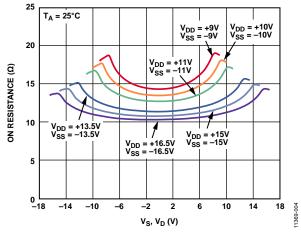


Figure 4. On Resistance as a Function of V_s, V_D (Dual Supply: ±10 V, ±15 V)

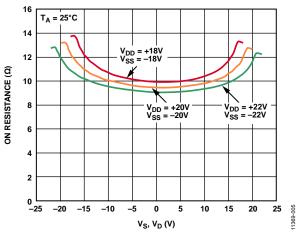


Figure 5. On Resistance as a Function of V_{S} , V_{D} (Dual Supply: $\pm 20 V$)

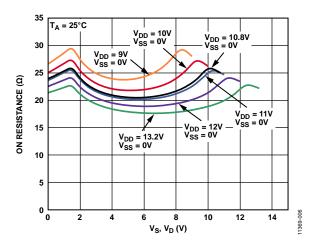


Figure 6. On Resistance as a Function of V_{S} , V_{D} (Single Supply: 10 V, 12 V)

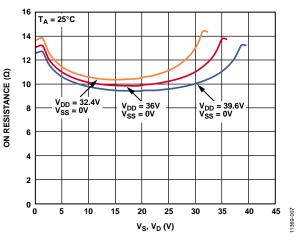


Figure 7. On Resistance as a Function of V_s, V_D (Single Supply: 36 V)

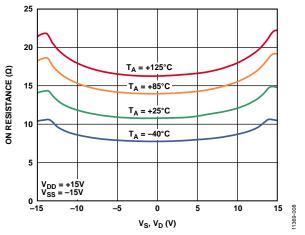


Figure 8. On Resistance as a Function of Vs (Vb) for Different Temperatures, ± 15 V Dual Supply

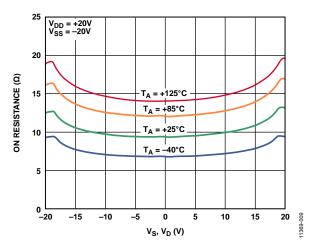


Figure 9. On Resistance as a Function of Vs (Vb) for Different Temperatures, ± 20 V Dual Supply

Data Sheet

40 35 30 = +125°C TΑ ON RESISTANCE (D) T_A = +85°C 25 T_A = +25°C 20 T_A = -40°C 15 10 5 V_{DD} = 12V V_{SS} = 0V 0 ^L 0 2 4 6 8 10 12 1369-010 $V_S,\,V_D\,(V)$

Figure 10. On Resistance as a Function of V_S (V_D) for Different Temperatures, 12 V Single Supply

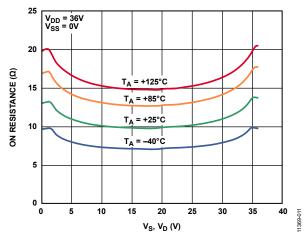


Figure 11. On Resistance as a Function of $V_S(V_D)$ for Different Temperatures, 36 V Single Supply

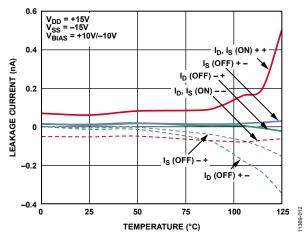


Figure 12. Leakage Currents as a Function of Temperature, ±15 V Dual Supply

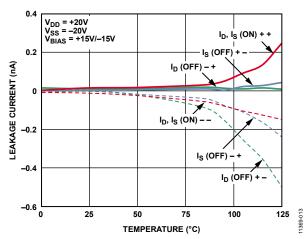


Figure 13. Leakage Currents as a Function of Temperature, ±20 V Dual Supply

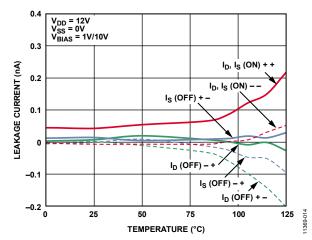


Figure 14. Leakage Currents as a Function of Temperature, 12 V Single Supply

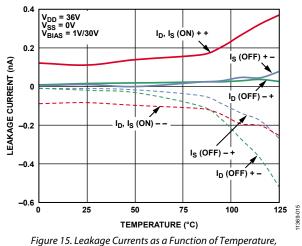
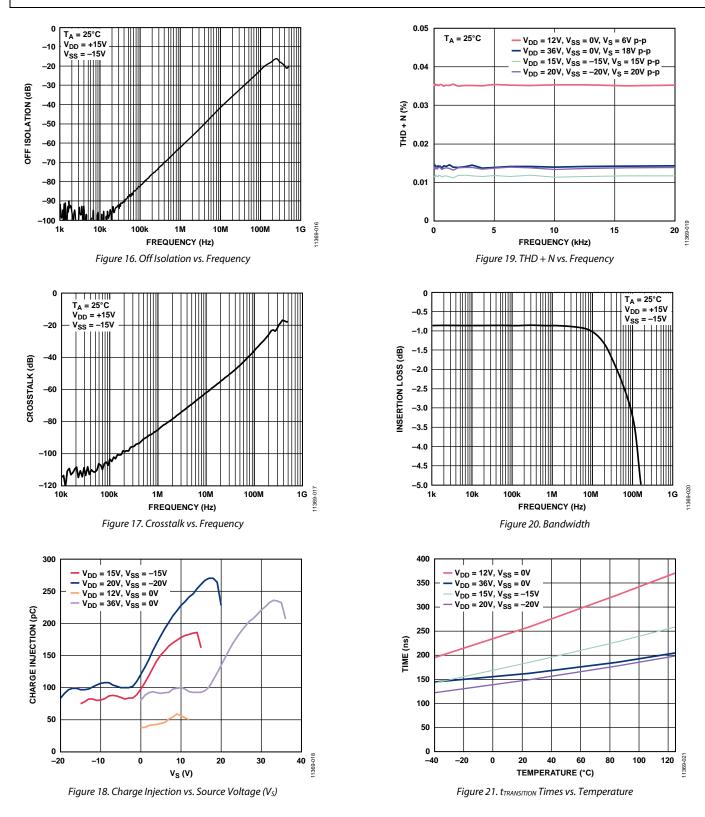


Figure 15. Leakage Currents as a Function of Temperature, 36 V Single Supply

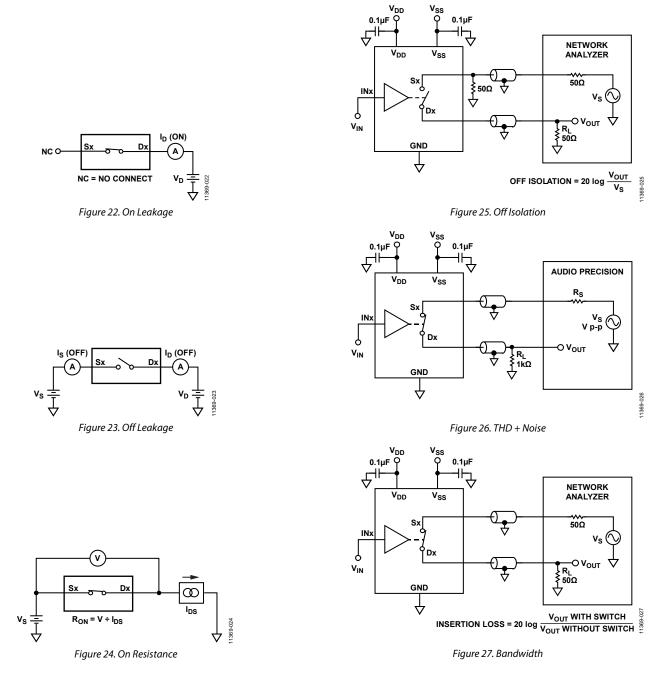


ADG5421/ADG5423

Data Sheet

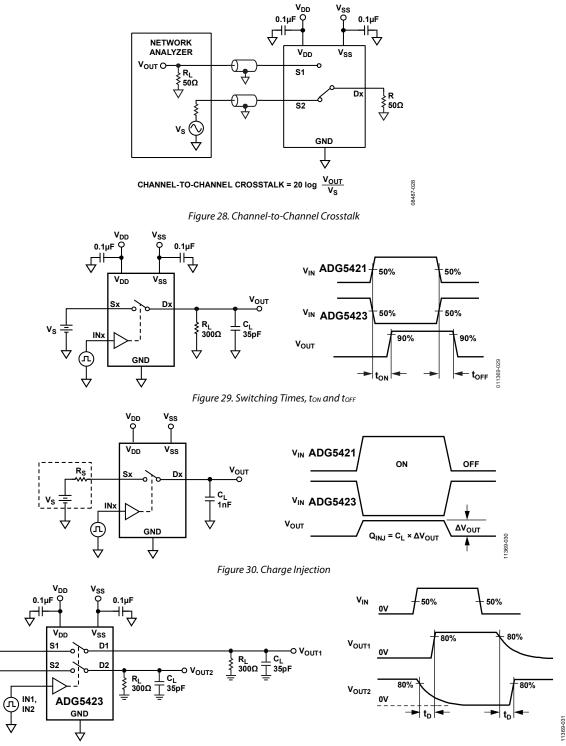


TEST CIRCUITS



V_{S1}

V_{S2}





TERMINOLOGY

Idd

IDD represents the positive supply current.

Iss

Iss represents the negative supply current.

VD, Vs

 $V_{\rm D}$ and $V_{\rm S}$ represent the analog voltage on Terminal D and Terminal S, respectively.

Ron

 $R_{\rm ON}$ is the ohmic resistance between Terminal D and Terminal S.

ΔR_{ON}

 $\Delta R_{\rm ON}$ represents the difference between the $R_{\rm ON}$ of any two channels.

RFLAT (ON)

 $R_{\rm FLAT\,(ON)}$ represents the difference between the maximum and minimum value of on resistance as measured over the specified analog signal range.

Is (Off)

 $I_{\text{S}}\left(\text{Off}\right)$ is the source leakage current with the switch off.

I_D (Off)

 $I_{\rm D}$ (Off) is the drain leakage current with the switch off.

I_D (On), I_S (On)

 $I_{\rm D}$ (On) and $I_{\rm S}$ (On) represent the channel leakage currents with the switch on.

VINL

 $V_{\ensuremath{\text{INL}}}$ is the maximum input voltage for Logic 0.

VINH

 $V_{\mbox{\scriptsize INH}}$ is the minimum input voltage for Logic 1.

$I_{\rm INL}, I_{\rm INH}$

 $I_{\rm INL}$ and $I_{\rm INH}$ represent the low and high input currents of the digital inputs.

C_D (Off)

 C_D (Off) represents the off switch drain capacitance, which is measured with reference to ground.

Cs (Off)

 C_{s} (Off) represents the off switch source capacitance, which is measured with reference to ground.

C_{D} (On), C_{S} (On)

 C_D (On) and C_S (On) represent on switch capacitances, which are measured with reference to ground.

ADG5421/ADG5423

CIN

CIN represents digital input capacitance.

ton

 $t_{\rm ON}$ represents the delay time between the 50% and 90% points of the digital input and switch on condition.

toff

 t_{OFF} represents the delay time between the 50% and 90% points of the digital input and switch off condition.

t_D

t_D represents the off time measured between the 80% point of both switches when switching from one address state to another.

Off Isolation

Off isolation is a measure of unwanted signal coupling through an off channel.

Charge Injection

Charge injection is a measure of the glitch impulse transferred from the digital input to the analog output during switching.

Crosstalk

Crosstalk is a measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

Bandwidth

Bandwidth is the frequency at which the output is attenuated by 3 dB from its dc level.

Total Harmonic Distortion + Noise (THD + N)

The ratio of the harmonic amplitude plus noise of the signal to the fundamental is represented by THD + N.

APPLICATIONS INFORMATION

The ADG54xx family of switches and multiplexers provide a robust solution for instrumentation, industrial, aerospace, and other harsh environments that are prone to latch-up, which is an undesirable high current state that can lead to device failure and persists until the power supply is turned off. The ADG5421/ ADG5423 high voltage switches allow single-supply operation from 9 V to 40 V and dual-supply operation from \pm 9 V to \pm 22 V. The ADG5421/ADG5423 (as well as other select devices within this family) achieve an 8 kV human body model ESD rating, which provides a robust solution, eliminating the need for separate protection circuitry designs in some applications.

TRENCH ISOLATION

In the ADG5421/ADG5423, an insulating oxide layer (trench) is placed between the NMOS and the PMOS transistors of each CMOS switch. Parasitic junctions, which occur between the transistors in junction-isolated switches, are eliminated, and the result is a completely latch-up immune switch.

In junction isolation, the N and P wells of the PMOS and NMOS transistors form a diode that is reverse-biased under normal operation. However, during overvoltage conditions, this diode can become forward-biased. The two transistors form a silicon-controlled rectifier (SCR) type circuit, causing a significant amplification of the current that, in turn, leads to latch-up. With trench isolation, this diode is removed, and the result is a latch-up immune switch.

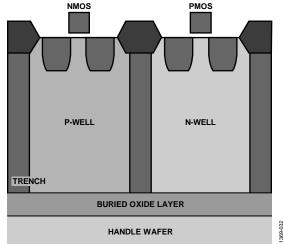
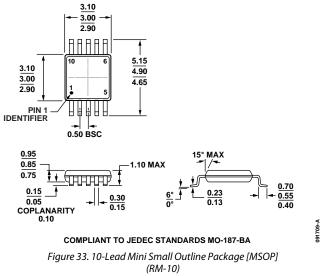


Figure 32. Trench Isolation

OUTLINE DIMENSIONS



Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option	Branding
ADG5421BRMZ	-40°C to +125°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	S47
ADG5421BRMZ-RL7	-40°C to +125°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	S47
ADG5423BRMZ	-40°C to +125°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	S3D
ADG5423BRMZ-RL7	-40°C to +125°C	10-Lead Mini Small Outline Package [MSOP]	RM-10	S3D

 1 Z = RoHS Compliant Part.

NOTES

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Data Sheet

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